



SBRT3U40P1

3A Trench SBR TRENCH SUPER BARRIER RECTIFIER POWERDI®123

Product Summary (@TA = +25°C)

V _{RRM} (V)	I _O (A)	V _F max (V)	I _{R max} (μA)
40	3	0.49	180

Description

Packaged in the compact thermally efficient POWERDI-123 package, the SBRT3U40P1 provides very low V_F and excellent reverse leakage stability at high temperatures. It is ideally suited to use as a rectifier diode in MR16 bridge rectifier applications.

Application

- Bridge Diodes
- Blocking Diodes
- Reverse Protection Diodes



Top View

Features and Benefits

- Reduced ultra-low forward voltage drop (V_F); better efficiency and cooler operation.
- Reduced high temperature reverse leakage; Increased reliability against thermal runaway failure in high temperature operation.
- <1.1mm package profile ideal for thin applications.
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDI123
- Case Material: Molded Plastic, "Green" Molding compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 63
- Polarity: See Below
- Weight: 0.01 grams (Approximate)



Device Symbol

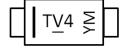
Ordering Information (Note 4)

Part Number	Case	Packaging
SBRT3U40P1-7	PowerDI-123	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



TV4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

Year	2013	2014	2015	2016	2017	2018	2019	2020
Code	Α	В	С	D	Е	F	G	Н

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	40	٧
Average Rectified Output Current	Io	3	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	75	А

Thermal Characteristics

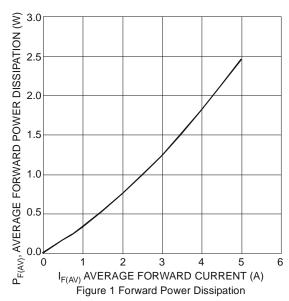
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	78	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	R ₀ JC	19	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

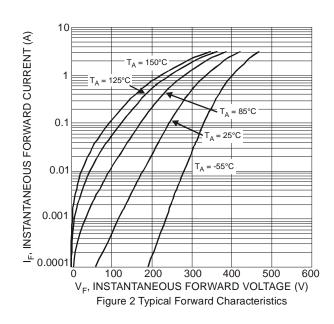
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	V _F	=	0.34 0.25 0.42 0.37	0.39 — 0.49 —	V	$I_F = 1A, T_J = +25^{\circ}C$ $I_F = 1A, T_J = +125^{\circ}C$ $I_F = 3A, T_J = +25^{\circ}C$ $I_F = 3A, T_J = +125^{\circ}C$
Leakage Current (Note 6)	I _R	_	30 7	180 40	μA mA	$V_R = 40V, T_J = +25$ °C $V_R = 40V, T_J = +125$ °C

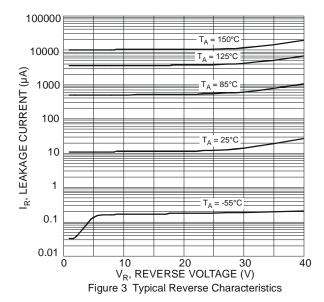
Notes:

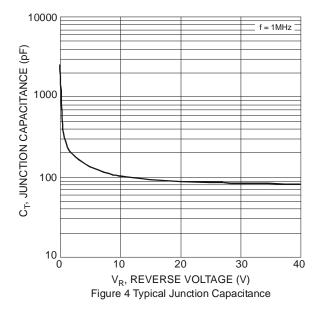
- 5. Device mounted on 1 inch FR4.
- 6. Short duration pulse test used to minimize self-heating effect.

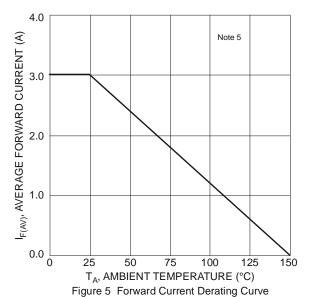


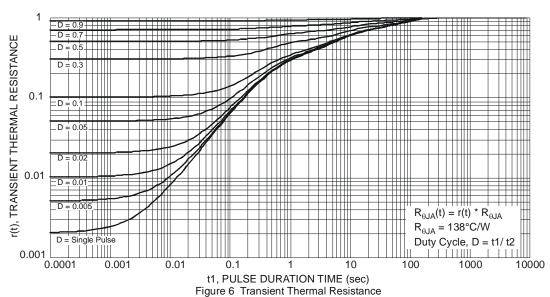








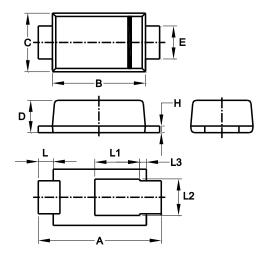






Package Outline Dimensions

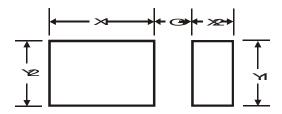
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	POWERDI [®] 123								
Dim	Min	Max	Тур						
Α	3.50	3.90	3.70						
В	2.60	3.00	2.80						
С	1.63	1.93	1.78						
D	0.93	1.00	0.98						
Е	0.85	1.25	1.00						
Н	0.15	0.25	0.20						
L	0.40	0.50	0.45						
L1	1.25	1.40	1.35						
L2	1.025	1.125	1.10						
L3	0.125	0.275	0.20						
All I	Dimens	ions in	mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	1.0
X1	2.2
X2	0.9
Y1	1.4
Y2	1.4



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